
HM5116405I Series

4,194,304-word × 4-bit Dynamic RAM

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ADE-203-757A (Z)

Rev. 1.0

Mar. 17, 1997

Description

The Hitachi HM5116405I Series is CMOS dynamic RAM organized 4,194,304-word × 4-bit. It employs the most advanced CMOS technology for high performance and low power. The HM5116405I Series offers Extended Data Out (EDO) Page Mode as a high speed access mode. It is packaged in 26-pin plastic SOJ.

Features

- Single 5 V ($\pm 10\%$)
- Access time: 60 ns/70 ns (max)
- Power dissipation
 - Active mode : 440 mW/385 mW (max)
 - Standby mode : 11 mW (max)
: 0.83 mW (max) (L-version)
- EDO page mode capability
- Refresh cycles
 - 4096 refresh cycles : 64 ms
: 128 ms (L-version)
- 3 variations of refresh
 - $\overline{\text{RAS}}$ -only refresh
 - $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh
 - Hidden refresh
- Battery backup operation (L-version)
- Test function
 - 16-bit parallel test mode
- Temperature range: -40 to $+85^{\circ}\text{C}$

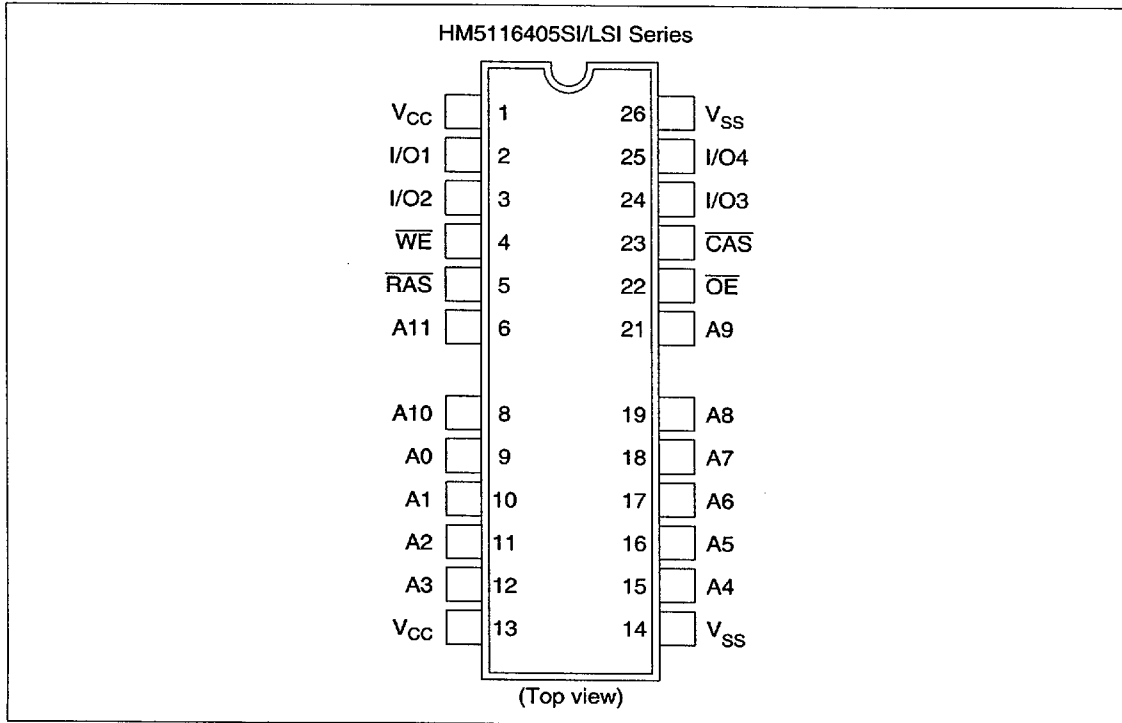
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Ordering Information

Type No.	Access time	Package
HM5116405SI-6	60 ns	300-mil 26-pin plastic SOJ (CP-26/24DB)
HM5116405SI-7	70 ns	
HM5116405LSI-6	60 ns	
HM5116405LSI -7	70 ns	

Pin Arrangement

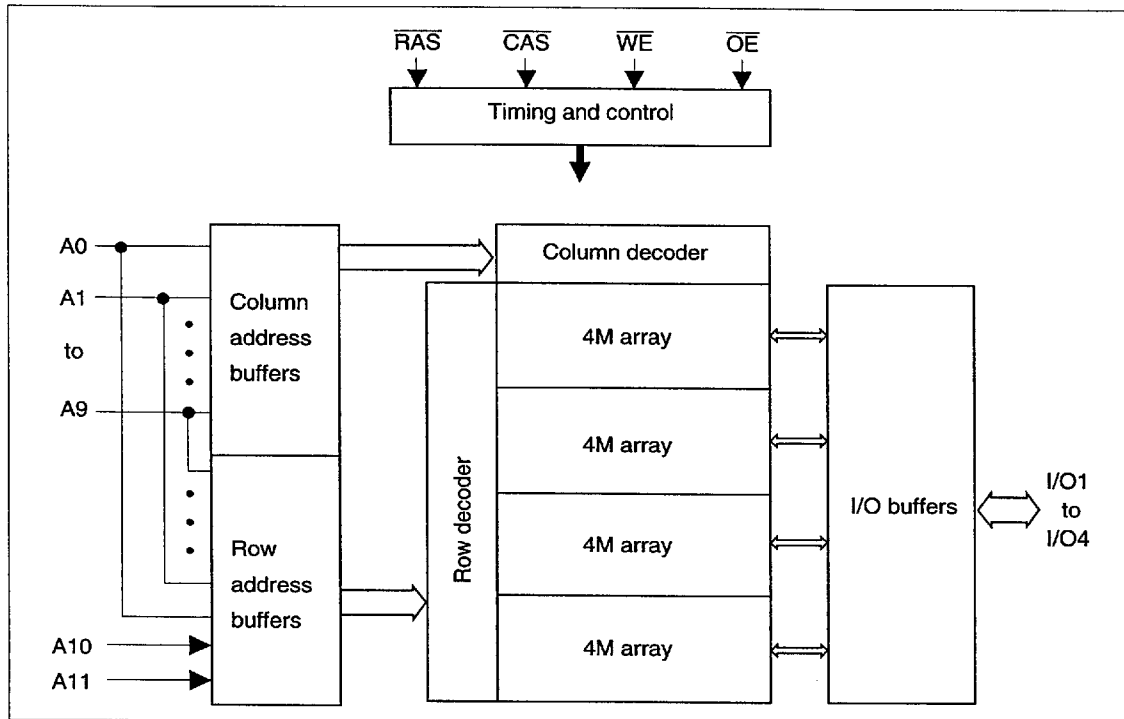


Pin Description

Pin name	Function
A0 to A11	Address input — Row/Refresh address A0 to A11 — Column address A0 to A9
I/O1 to I/O4	Data input/Data output
RAS	Row address strobe
CAS	Column address strobe
WE	Write enable
OE	Output enable
V _{CC}	Power supply
V _{SS}	Ground

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Block Diagram



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Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Voltage on any pin relative to V_{SS}	V_T	-1.0 to +7.0	V
Supply voltage relative to V_{SS}	V_{CC}	-1.0 to +7.0	V
Short circuit output current	I_{out}	50	mA
Power dissipation	P_T	1.0	W
Operating temperature	T_{opr}	-40 to +85	°C
Storage temperature	T_{stg}	-55 to +125	°C

Recommended DC Operating Conditions ($T_a = -40$ to $+85^\circ\text{C}$)

Parameter	Symbol	Min	Typ	Max	Unit	Note
Supply voltage	V_{CC}	4.5	5.0	5.5	V	1
Input high voltage	V_{IH}	2.4	—	6.5	V	1
Input low voltage	V_{IL}	-1.0	—	0.8	V	1

Note: 1. All voltage referred to V_{SS} .

DC Characteristics ($T_a = -40$ to $+85^\circ\text{C}$, $V_{CC} = 5\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$)

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Parameter	Symbol	-6		-7		Unit	Test conditions
		Min	Max	Min	Max		
Operating current*1, *2	I_{CC1}	—	80	—	70	mA	$t_{RC} = \min$
Standby current	I_{CC2}	—	2	—	2	mA	TTL interface $\overline{RAS}, \overline{CAS} = V_{IH}$ Dout = High-Z
		—	1	—	1	mA	CMOS interface $\overline{RAS}, \overline{CAS} \geq V_{CC} - 0.2\text{ V}$ Dout = High-Z
Standby current (L-version)	I_{CC2}	—	150	—	150	μA	CMOS interface $\overline{RAS}, \overline{CAS} \geq V_{CC} - 0.2\text{ V}$ Dout = High-Z
$\overline{RAS}$ -only refresh current*2	I_{CC3}	—	80	—	70	mA	$t_{RC} = \min$
Standby current*1	I_{CC5}	—	5	—	5	mA	$\overline{RAS} = V_{IH}$ $\overline{CAS} = V_{IL}$ Dout = enable
$\overline{CAS}$ -before- $\overline{RAS}$ refresh current	I_{CC6}	—	80	—	70	mA	$t_{RC} = \min$

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DC Characteristics (cont.)

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Parameter	Symbol	-6		-7		Unit	Test conditions
		Min	Max	Min	Max		
EDO page mode current ^{*1, *3}	I _{CC7}	—	70	—	65	mA	t _{HPC} = min
Battery backup current	I _{CC10}	—	350	—	350	μA	CMOS interface Dout = High-Z, CBR refresh: t _{RC} = 31.3 μs t _{RAS} ≤ 0.3 μs
Input leakage current	I _{LI}	−10	10	−10	10	μA	0 V ≤ Vin ≤ 7 V
Output leakage current	I _{LO}	−10	10	−10	10	μA	0 V ≤ Vin ≤ 7 V Dout = disable
Output high voltage	V _{OH}	2.4	V _{CC}	2.4	V _{CC}	V	High Iout = −2 mA
Output low voltage	V _{OL}	0	0.4	0	0.4	V	Low Iout = 2 mA

Notes : 1. I_{CC} depends on output load condition when the device is selected. I_{CC} max is specified at the output open condition.

2. Address can be changed once or less while $\overline{RAS} = V_{IL}$.

3. Address can be changed once or less while $\overline{CAS} = V_{IH}$.

Capacitance ($T_a = 25^\circ C$, $V_{CC} = 5 V \pm 10\%$)

Parameter	Symbol	Typ	Max	Unit	Notes
Input capacitance (Address)	C_{I1}	—	5	pF	1
Input capacitance (Clocks)	C_{I2}	—	7	pF	1
Output capacitance (Data-in, Data-out)	C_{VO}	—	7	pF	1, 2

Notes : 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.

2. $\overline{CAS} = V_{IH}$ to disable Dout.

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AC Characteristics ($T_a = -40$ to $+85^\circ\text{C}$, $V_{CC} = 5\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$) *¹, *², *¹⁸

Test Conditions

- Input rise and fall time: 2 ns
- Input levels: $V_{IL} = 0\text{ V}$, $V_{IH} = 3\text{ V}$
- Input timing reference levels: 0.8 V, 2.4 V
- Output timing reference levels: 0.8 V, 2.0 V
- Output load: 1 TTL gate + C_L (100 pF) (Including scope and jig)

Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

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		-6		-7			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Random read or write cycle time	t _{RC}	104	—	124	—	ns	
RAS precharge time	t _{RP}	40	—	50	—	ns	
CAS precharge time	t _{CP}	10	—	13	—	ns	
RAS pulse width	t _{RAS}	60	10000	70	10000	ns	
CAS pulse width	t _{CAS}	10	10000	13	10000	ns	
Row address setup time	t _{ASR}	0	—	0	—	ns	
Row address hold time	t _{RAH}	10	—	10	—	ns	
Column address setup time	t _{ASC}	0	—	0	—	ns	
Column address hold time	t _{CAH}	10	—	13	—	ns	
RAS to CAS delay time	t _{RCD}	14	45	14	52	ns	3
RAS to column address delay time	t _{RAD}	12	30	12	35	ns	4
RAS hold time	t _{RSH}	13	—	13	—	ns	
CAS hold time	t _{CSH}	40	—	45	—	ns	
CAS to RAS precharge time	t _{CRP}	5	—	5	—	ns	
OE to Din delay time	t _{OED}	15	—	18	—	ns	5
OE delay time from Din	t _{DZO}	0	—	0	—	ns	6
CAS delay time from Din	t _{DZC}	0	—	0	—	ns	6
Transition time (rise and fall)	t _T	2	50	2	50	ns	7

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Read Cycle

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Parameter	Symbol	-6		-7		Unit	Notes
		Min	Max	Min	Max		
Access time from $\overline{\text{RAS}}$	t_{RAC}	—	60	—	70	ns	8, 9, 20
Access time from $\overline{\text{CAS}}$	t_{CAC}	—	15	—	18	ns	9, 10, 17, 20
Access time from address	t_{AA}	—	30	—	35	ns	9, 11, 17, 20
Access time from $\overline{\text{OE}}$	t_{OEA}	—	15	—	18	ns	9, 20
Read command setup time	t_{RCS}	0	—	0	—	ns	
Read command hold time to $\overline{\text{CAS}}$	t_{RCH}	0	—	0	—	ns	12
Read command hold time from $\overline{\text{RAS}}$	t_{RCHR}	60	—	70	—	ns	
Read command hold time to $\overline{\text{RAS}}$	t_{RRH}	0	—	0	—	ns	12
Column address to $\overline{\text{RAS}}$ lead time	t_{RAL}	30	—	35	—	ns	
Column address to $\overline{\text{CAS}}$ lead time	t_{CAL}	18	—	23	—	ns	
$\overline{\text{CAS}}$ to output in low-Z	t_{CLZ}	0	—	0	—	ns	
Output data hold time	t_{OH}	3	—	3	—	ns	22
Output data hold time from $\overline{\text{OE}}$	t_{OHO}	3	—	3	—	ns	
Output buffer turn-off time	t_{OFF}	—	15	—	15	ns	13, 22
Output buffer turn-off to $\overline{\text{OE}}$	t_{OEZ}	—	15	—	15	ns	13
$\overline{\text{CAS}}$ to Din delay time	t_{CDD}	15	—	18	—	ns	5
Output data hold time from $\overline{\text{RAS}}$	t_{OHR}	3	—	3	—	ns	22
Output buffer turn-off to $\overline{\text{RAS}}$	t_{OFR}	—	15	—	15	ns	22
Output buffer turn-off to $\overline{\text{WE}}$	t_{WEZ}	—	15	—	15	ns	
$\overline{\text{WE}}$ to Din delay time	t_{WED}	15	—	18	—	ns	
$\overline{\text{RAS}}$ to Din delay time	t_{RDD}	15	—	18	—	ns	
$\overline{\text{RAS}}$ next $\overline{\text{CAS}}$ delay time	t_{RNCD}	60	—	70	—	ns	

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Write Cycle

HM5116405I							
Parameter	Symbol	-6		-7		Unit	Notes
		Min	Max	Min	Max		
Write command setup time	t _{WCS}	0	—	0	—	ns	14
Write command hold time	t _{WCH}	10	—	13	—	ns	
Write command pulse width	t _{WP}	10	—	10	—	ns	
Write command to $\overline{\text{RAS}}$ lead time	t _{RWL}	10	—	13	—	ns	
Write command to $\overline{\text{CAS}}$ lead time	t _{CWL}	10	—	13	—	ns	
Data-in setup time	t _{DS}	0	—	0	—	ns	15
Data-in hold time	t _{DH}	10	—	13	—	ns	15

Read-Modify-Write Cycle

		HM5116405I					
		-6		-7			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Read-modify-write cycle time	t _{RWC}	135	—	161	—	ns	
RAS to $\overline{WE}$ delay time	t _{RWD}	79	—	92	—	ns	14
$\overline{CAS}$ to $\overline{WE}$ delay time	t _{CWD}	34	—	40	—	ns	14
Column address to $\overline{WE}$ delay time	t _{AWD}	49	—	57	—	ns	14
$\overline{OE}$ hold time from $\overline{WE}$	t _{OEHL}	15	—	18	—	ns	

Refresh Cycle

Parameter	Symbol	HM5116405I				Unit	Notes
		-6		-7			
		Min	Max	Min	Max		
CAS setup time (CBR refresh cycle)	t _{CSR}	5	—	5	—	ns	
CAS hold time (CBR refresh cycle)	t _{CHR}	10	—	10	—	ns	
WE setup time (CBR refresh cycle)	t _{WRP}	0	—	0	—	ns	
WE hold time (CBR refresh cycle)	t _{WRH}	10	—	10	—	ns	
RAS precharge to CAS hold time	t _{RPC}	5	—	5	—	ns	

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EDO Page Mode Cycle

		HM5116405I					
		-6		-7			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
EDO page mode cycle time	t _{HPC}	25	—	30	—	ns	21
EDO page mode RAS pulse width	t _{RASP}	—	100000	—	100000	ns	16
Access time from CAS precharge	t _{CPA}	—	35	—	40	ns	9, 17, 20
RAS hold time from CAS precharge	t _{CPRH}	35	—	40	—	ns	
Output data hold time from CAS low	t _{DOH}	3	—	3	—	ns	9, 17
CAS hold time referred OE	t _{COL}	10	—	13	—	ns	
CAS to OE setup time	t _{COP}	5	—	5	—	ns	
Read command hold time from CAS precharge	t _{RCHC}	35	—	40	—	ns	

EDO Page Mode Read-Modify-Write Cycle

		HM5116405I					
		-6		-7			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
EDO page mode read- modify-write cycle time	t _{HPRWC}	68	—	79		ns	
WE delay time from CAS precharge	t _{CPW}	54	—	62		ns	14

Test Mode Cycle *19

		HM5116405I					
		-6		-7			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Test mode $\overline{WE}$ setup time	t_{WTS}	0	—	0	—	ns	
Test mode $\overline{WE}$ hold time	t_{WTH}	10	—	10	—	ns	

Refresh

Parameter	Symbol	Max	Unit	Notes
Refresh period	t_{REF}	64	ms	4096 cycles
Refresh period (L-version)	t_{REF}	128	ms	4096 cycles

- Notes: 1. AC measurements assume $t_T = 2 \text{ ns}$.
2. An initial pause of 200 μs is required after power up followed by a minimum of eight initialization cycles (any combination of cycles containing RAS-only refresh or CAS-before-RAS refresh). If the internal refresh counter is used, a minimum of eight $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh cycles are required.
 3. Operation with the t_{RCD} (max) limit insures that t_{RAC} (max) can be met, t_{RCD} (max) is specified as a reference point only; if t_{RCD} is greater than the specified t_{RCD} (max) limit, then access time is controlled exclusively by t_{CAC} .
 4. Operation with the t_{RAD} (max) limit insures that t_{RAC} (max) can be met, t_{RAD} (max) is specified as a reference point only; if t_{RAD} is greater than the specified t_{RAD} (max) limit, then access time is controlled exclusively by t_{AA} .
 5. Either t_{OED} or t_{CDD} must be satisfied.
 6. Either t_{DZO} or t_{DZC} must be satisfied.
 7. V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} (min) and V_{IL} (max).
 8. Assumes that $t_{\text{RCD}} \leq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \leq t_{\text{RAD}}$ (max). If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} exceeds the value shown.
 9. Measured with a load circuit equivalent to 1 TTL loads and 100 pF.
 10. Assumes that $t_{\text{RCD}} \geq t_{\text{RCD}}$ (max) and $t_{\text{RCD}} + t_{\text{CAC}}$ (max) $\geq t_{\text{RAD}} + t_{\text{AA}}$ (max).
 11. Assumes that $t_{\text{RAD}} \geq t_{\text{RAD}}$ (max) and $t_{\text{RCD}} + t_{\text{CAC}}$ (max) $\leq t_{\text{RAD}} + t_{\text{AA}}$ (max).
 12. Either t_{RCH} or t_{RRH} must be satisfied for a read cycles.
 13. t_{OFF} (max) and t_{OEZ} (max) define the time at which the outputs achieve the open circuit condition and are not referred to output voltage levels.
 14. t_{WCS} , t_{RWD} , t_{CWD} , t_{AWD} and t_{CPW} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only; if $t_{\text{WCS}} \geq t_{\text{WCS}}$ (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if $t_{\text{RWD}} \geq t_{\text{RWD}}$ (min), $t_{\text{CWD}} \geq t_{\text{CWD}}$ (min), and $t_{\text{AWD}} \geq t_{\text{AWD}}$ (min), or $t_{\text{CWD}} \geq t_{\text{CWD}}$ (min), $t_{\text{AWD}} \geq t_{\text{AWD}}$ (min) and $t_{\text{CPW}} \geq t_{\text{CPW}}$ (min), the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
 15. These parameters are referred to $\overline{\text{CAS}}$ leading edge in early write cycles and to $\overline{\text{WE}}$ leading edge in delayed write or read-modify-write cycles.
 16. t_{RASP} defines $\overline{\text{RAS}}$ pulse width in EDO page mode cycles.
 17. Access time is determined by the longest among t_{AA} , t_{CAC} and t_{CPA} .
 18. In delayed write or read-modify-write cycles, $\overline{\text{OE}}$ must disable output buffer prior to applying data to device.
 19. The 16M DRAM offers a 16-bit time saving parallel test mode. Address CA0 and CA1 for the 4M $\times 4$ are don't care during test mode. Test mode is set by performing a $\overline{\text{WE}}$ -and- $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ (WCBR) cycle. In 16-bit parallel test mode, data is written into 4 bits in parallel at each I/O (I/O1 to I/O4) and read out from each I/O.
If 4 bits of each I/O are equal (all 1s or 0s), data output pin is a high state during test mode read cycle, then the device has passed. If they are not equal, data output pin is a low state, then the device has failed.
Refresh during test mode operation can be performed by normal read cycles or by WCBR refresh cycles.
To get out of test mode and enter a normal operation mode, perform either a regular $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh cycle or RAS-only refresh cycle.
 20. In a test mode read cycle, the value of t_{RAC} , t_{AA} , t_{CAC} and t_{CPA} is delayed by 2 ns to 5 ns for the specified value. These parameters should be specified in test mode cycles by adding the above value to the specified value in this data sheet.

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21. t_{HPC} (min) can be achieved during a series of EDO page mode write cycles or EDO page mode read cycles. If both write and read operation are mixed in a EDO page mode $\overline{RAS}$ cycle (EDO page mode mix cycle (1), (2)), minimum value of $\overline{CAS}$ cycle ($t_{CAS} + t_{CP} + 2 t_r$) becomes greater than the specified t_{HPC} (min) value. The value of $\overline{CAS}$ cycle time of mixed EDO page mode is shown in EDO page mode mix cycle (1) and (2).
Data output turns off and becomes high impedance from later rising edge of $\overline{RAS}$ and $\overline{CAS}$.
Hold time and turn off time are specified by the timing specifications of later rising edge of $\overline{RAS}$ and $\overline{CAS}$ between t_{OHR} and t_{OH} , and between t_{OFR} and t_{OFF} .
22. Data output turns off and becomes high impedance from later rising edge of $\overline{RAS}$ and $\overline{CAS}$.
Hold time and turn off time are specified by the timing specifications of later rising edge of $\overline{RAS}$ and $\overline{CAS}$ between t_{OHR} and t_{OH} and between t_{OFR} and t_{OFF} .
23. XXX: H or L (H: $V_{IH}(\min) \leq V_{IN} \leq V_{IH}(\max)$, L: $V_{IL}(\min) \leq V_{IN} \leq V_{IL}(\max)$)
/////: Invalid Dout
When the address, clock and input pins are not described on timing waveforms, their pins must be applied V_{IH} or V_{IL} .

Timing Waveforms*²³

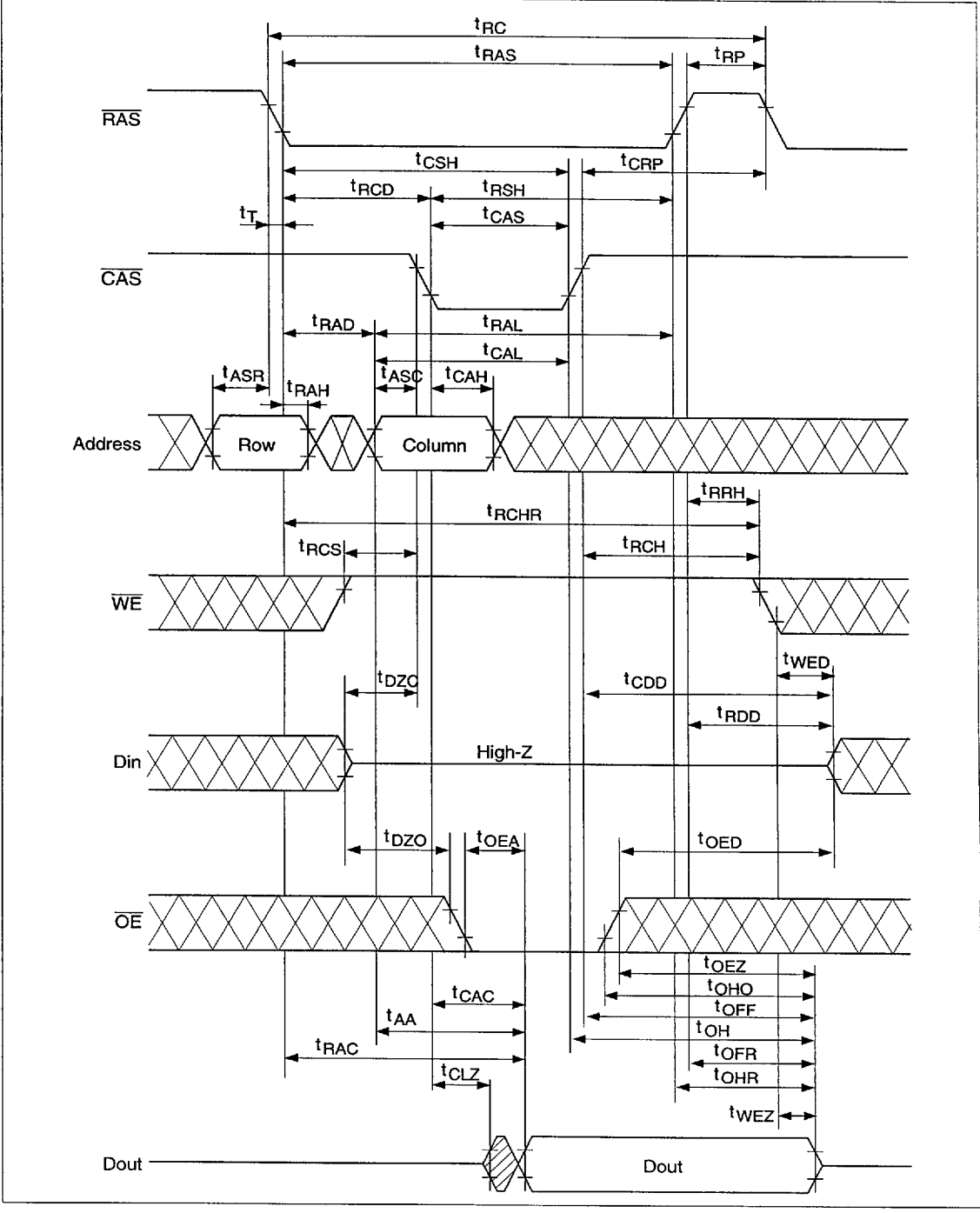
Read Cycle

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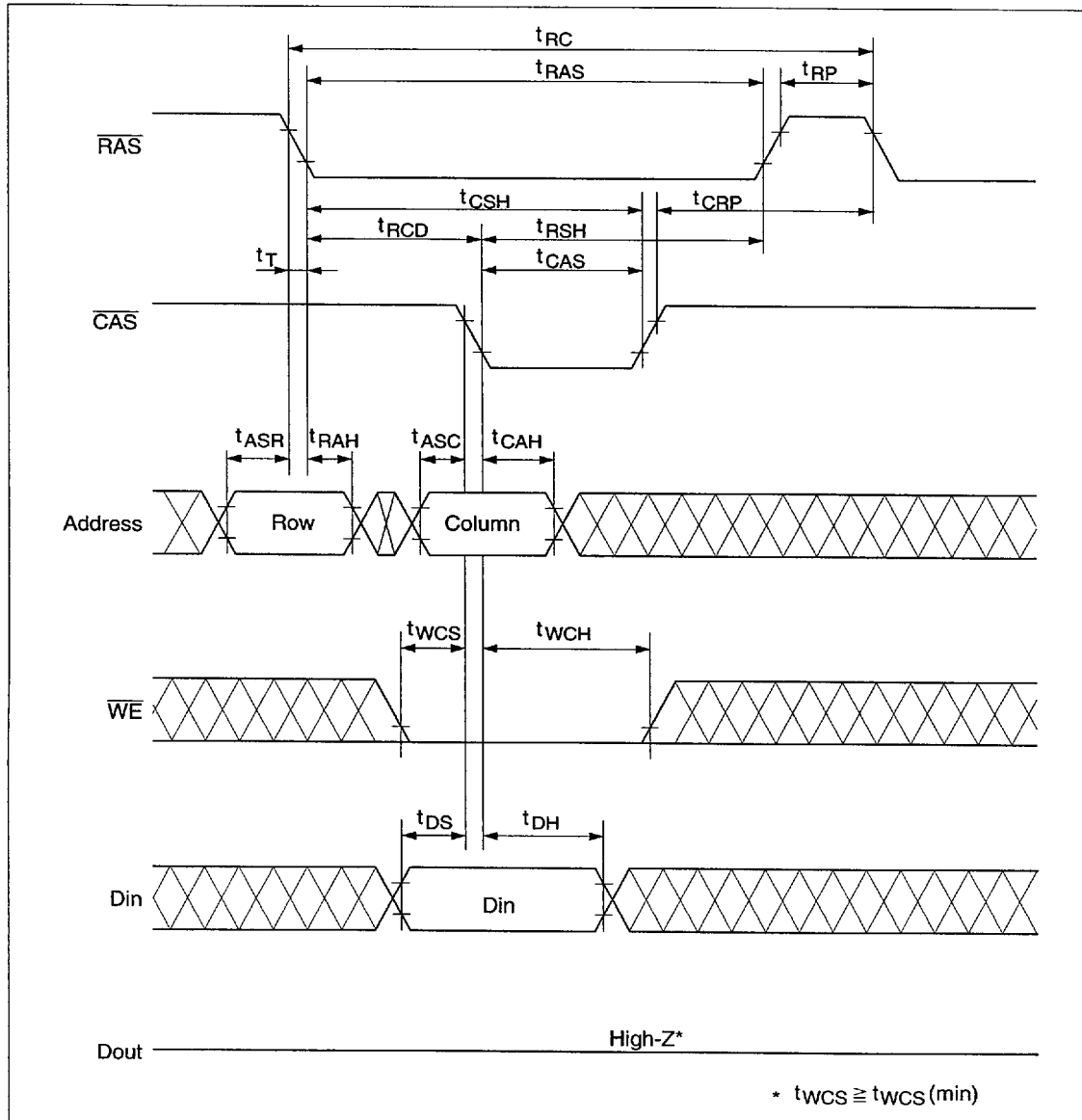
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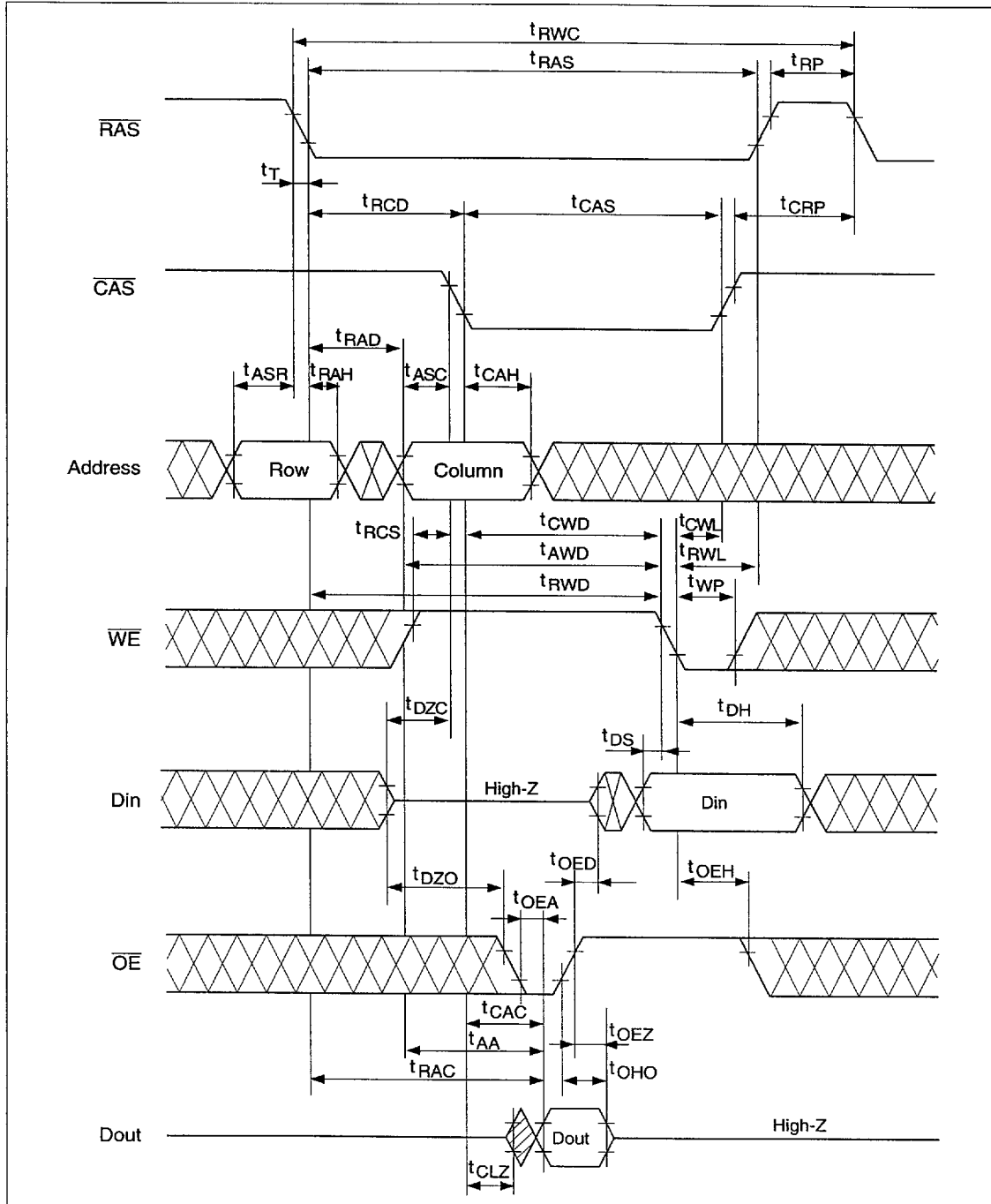
Early Write Cycle



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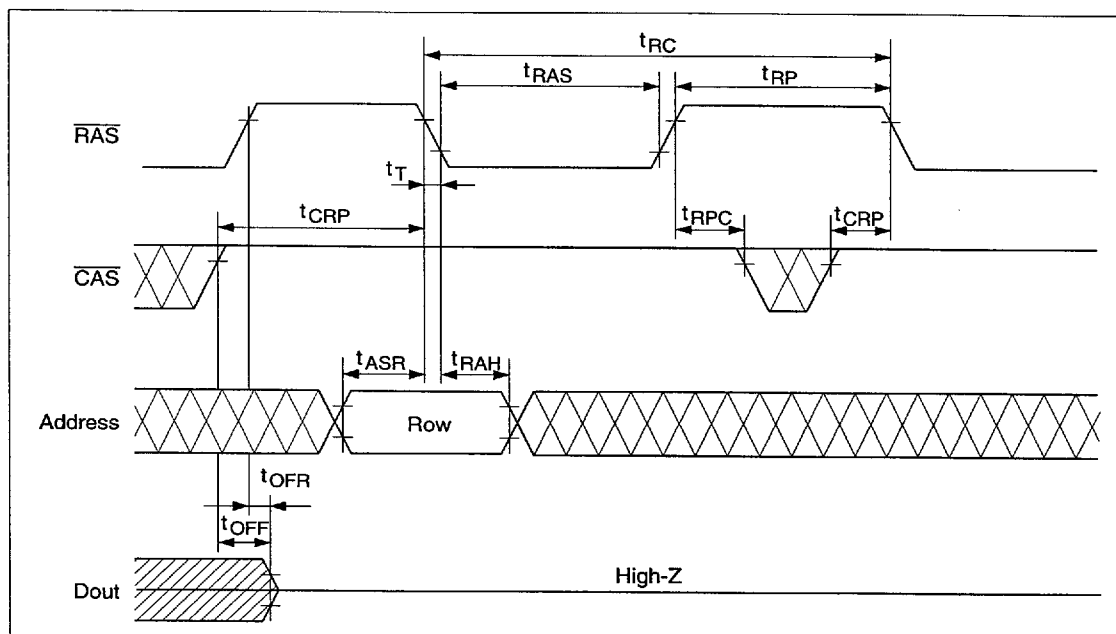
Read-Modify-Write Cycle*18



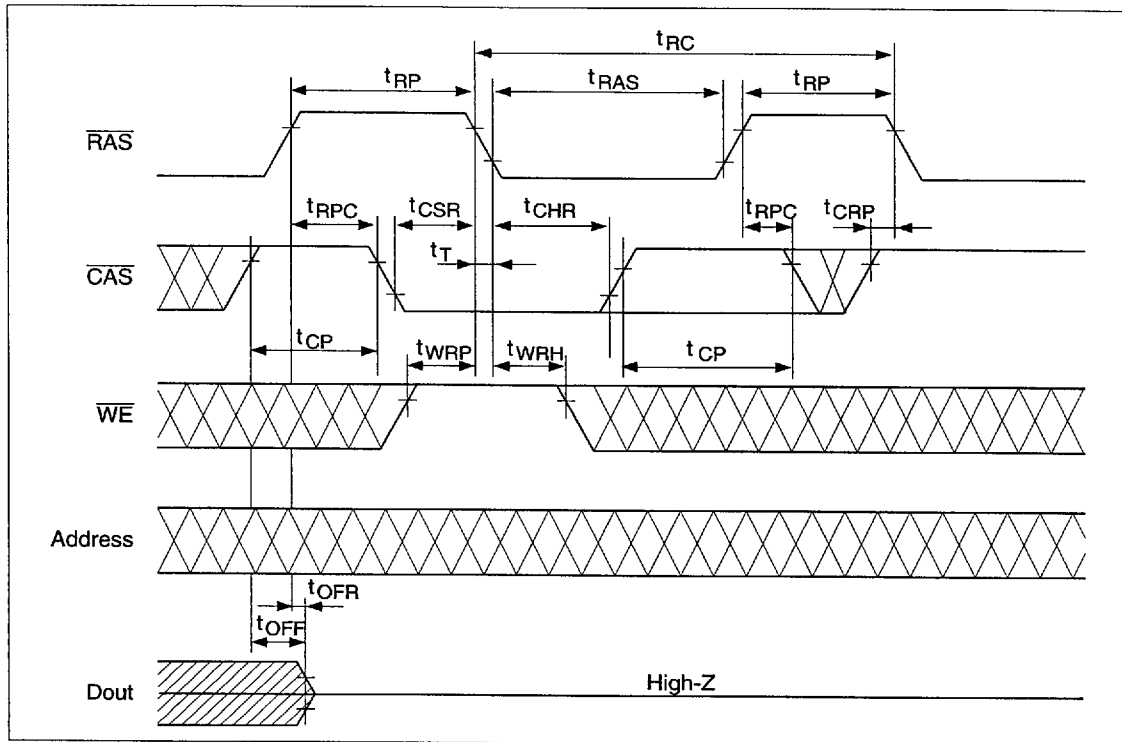
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RAS-Only Refresh Cycle

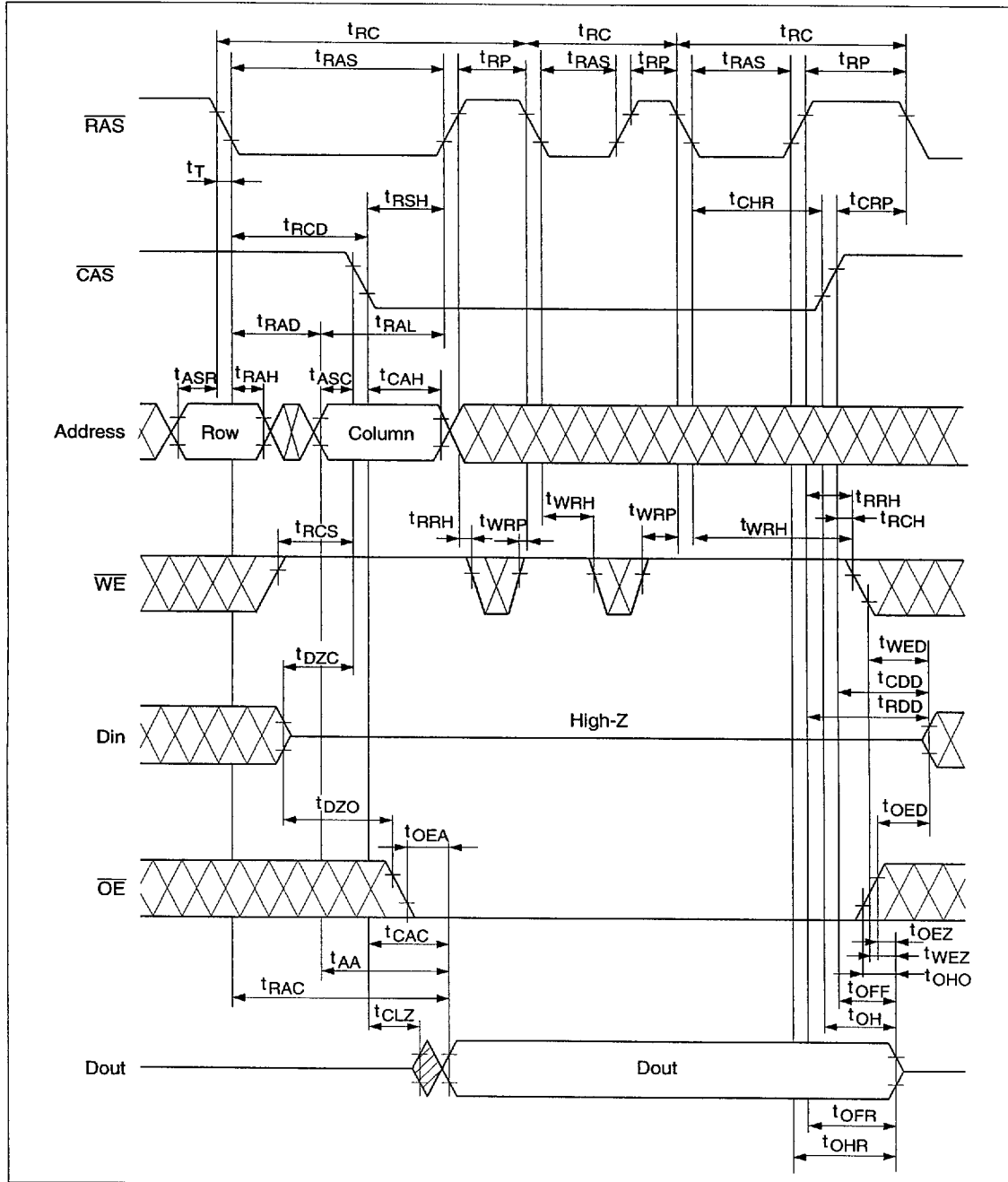


CAS-Before-RAS Refresh Cycle



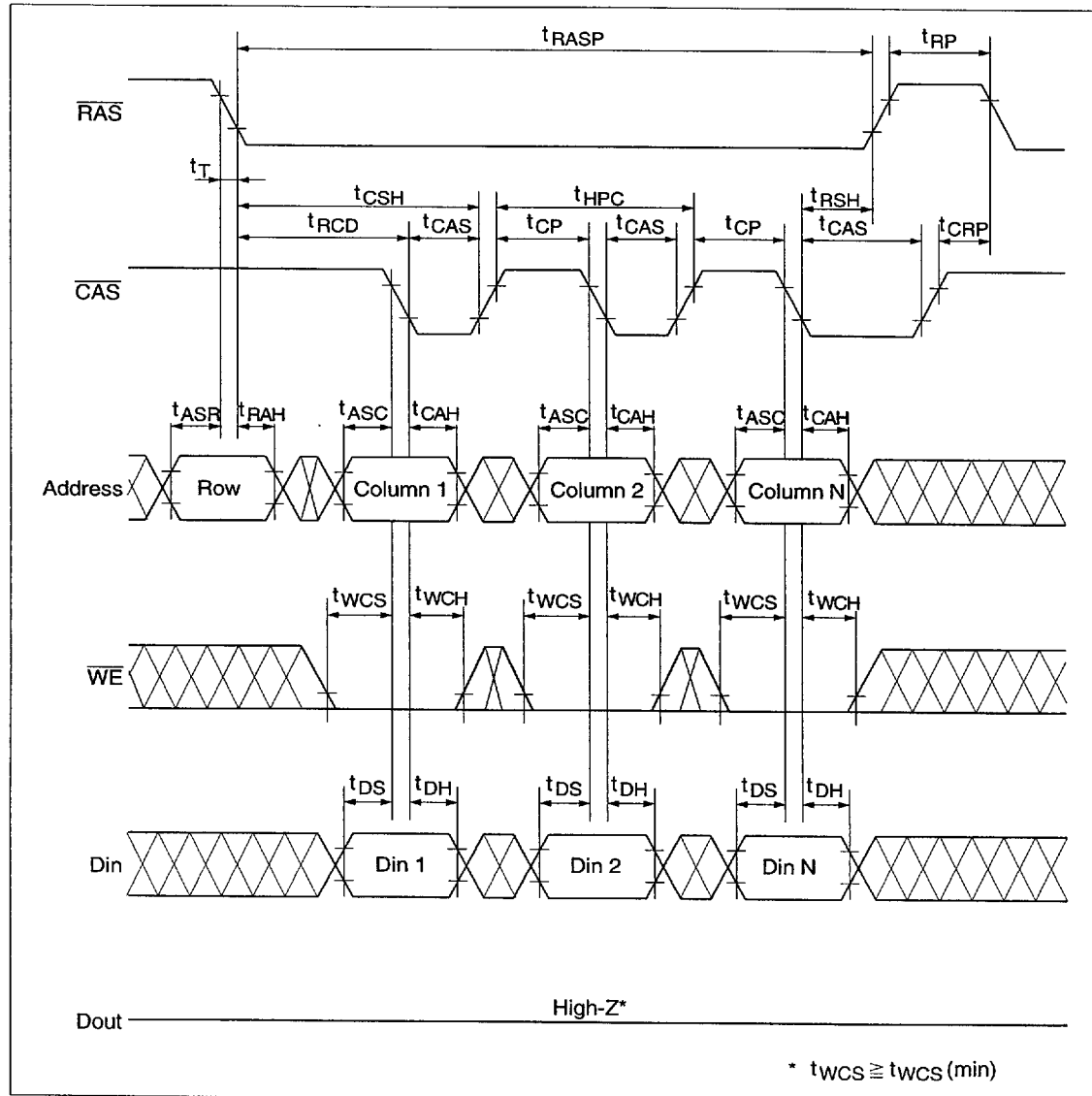
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Hidden Refresh Cycle

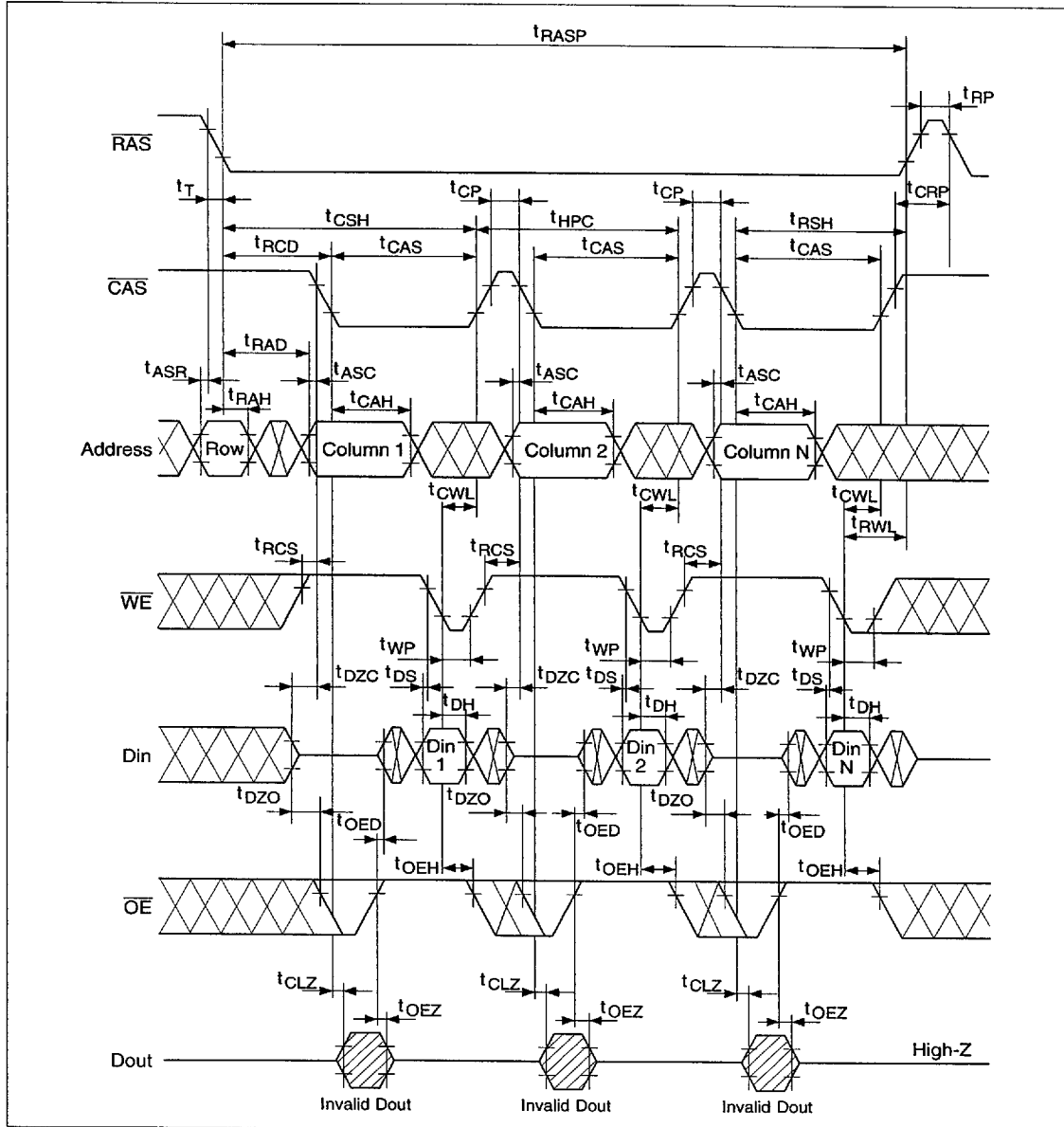


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EDO Page Mode Early Write Cycle

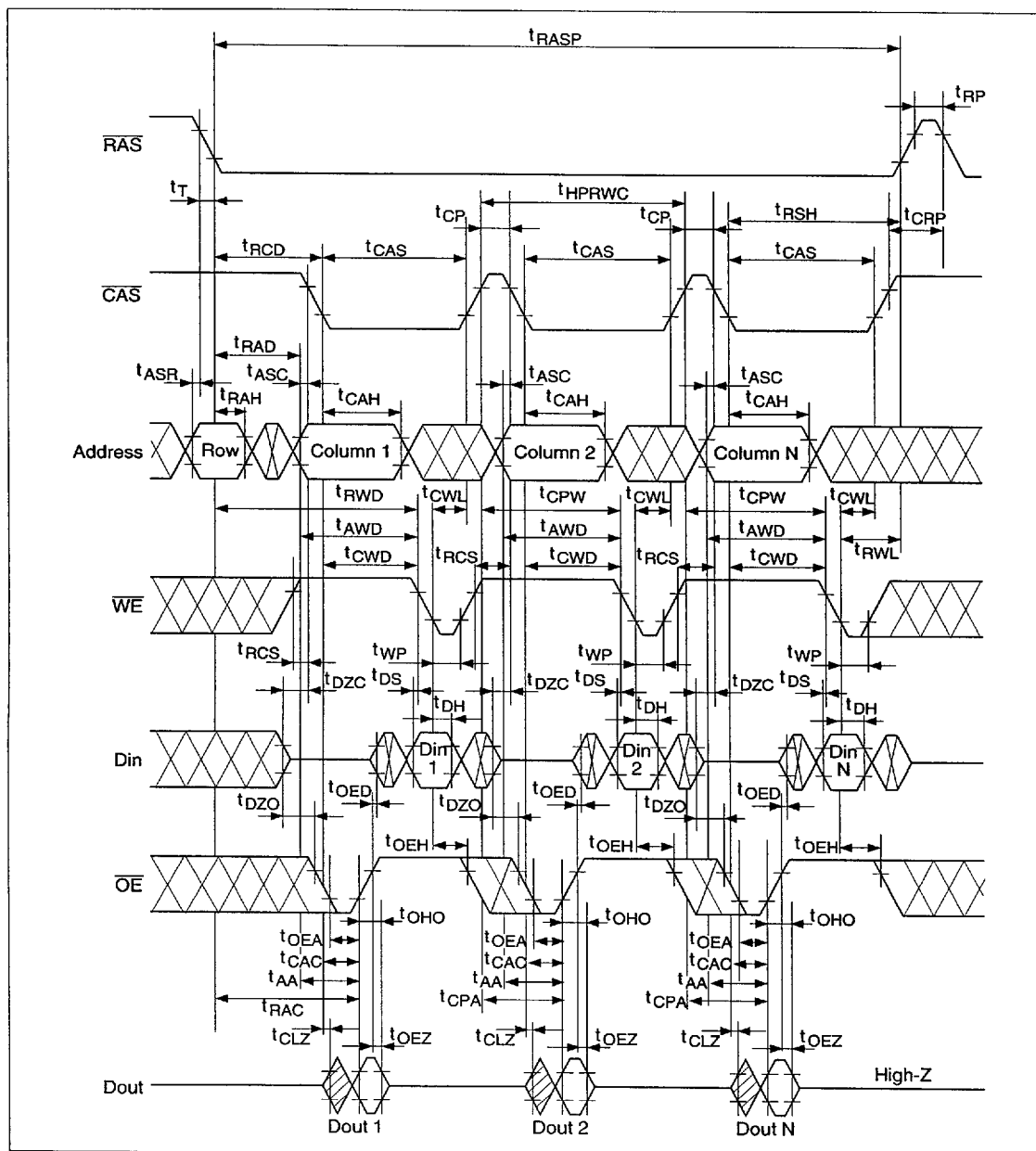


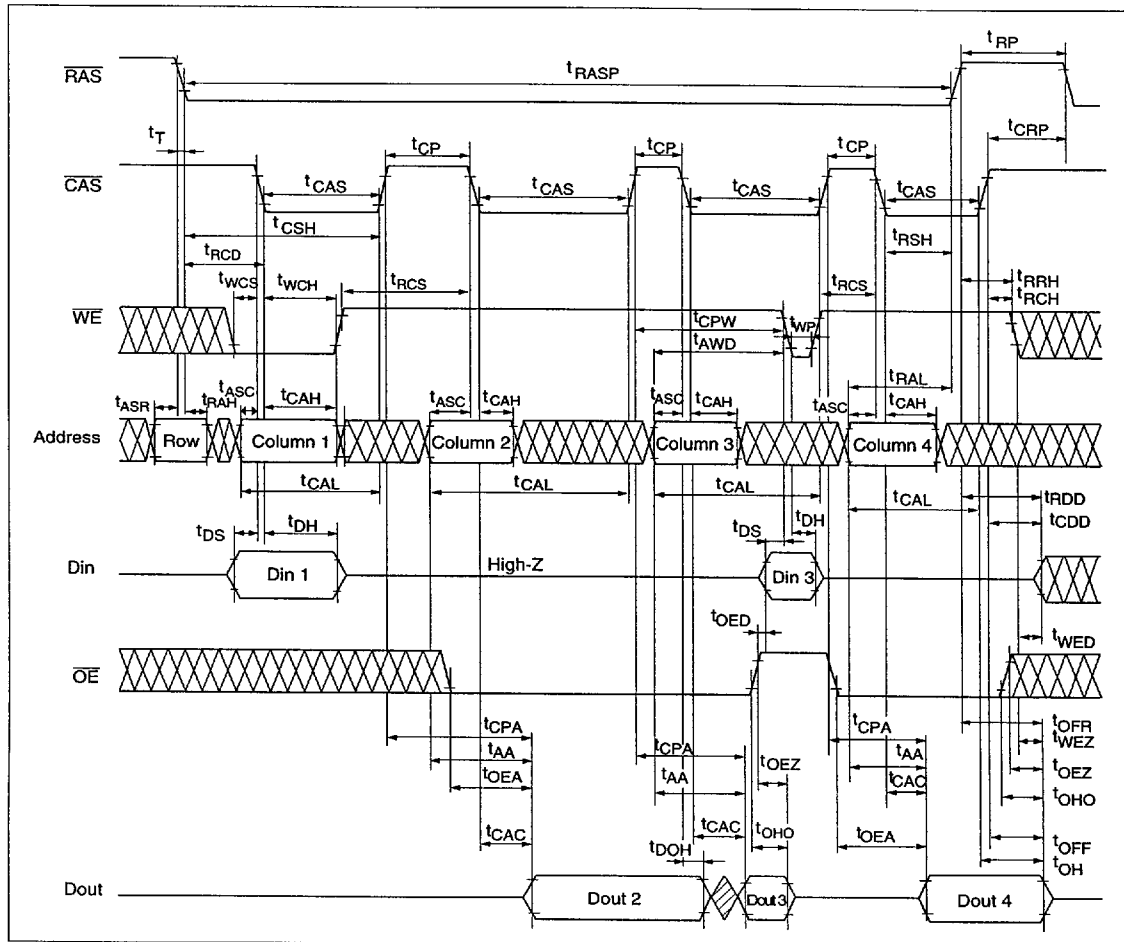
EDO Page Mode Delayed Write Cycle*18



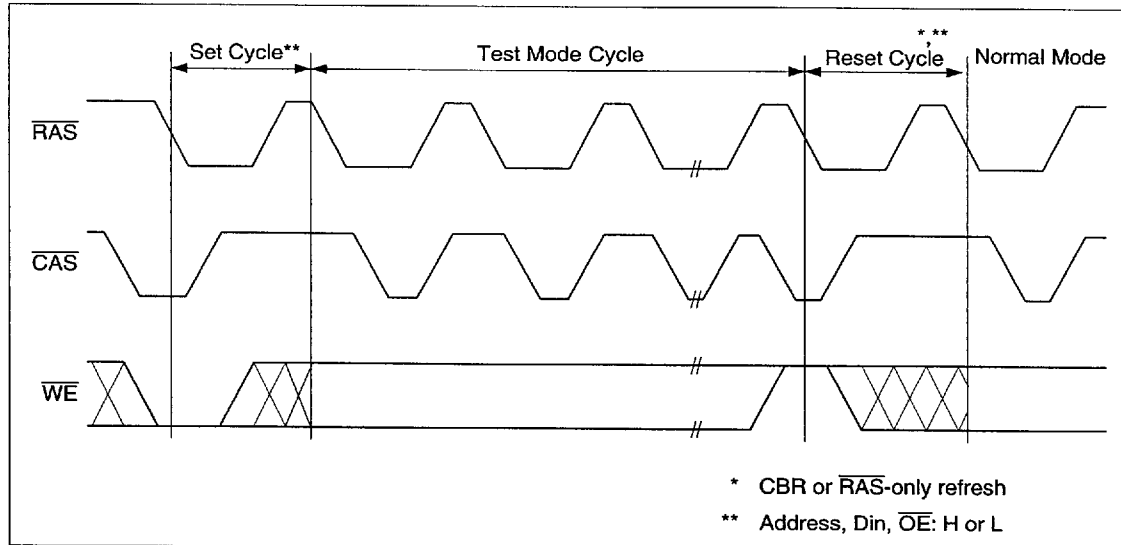
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EDO Page Mode Read-Modify-Write Cycle*18



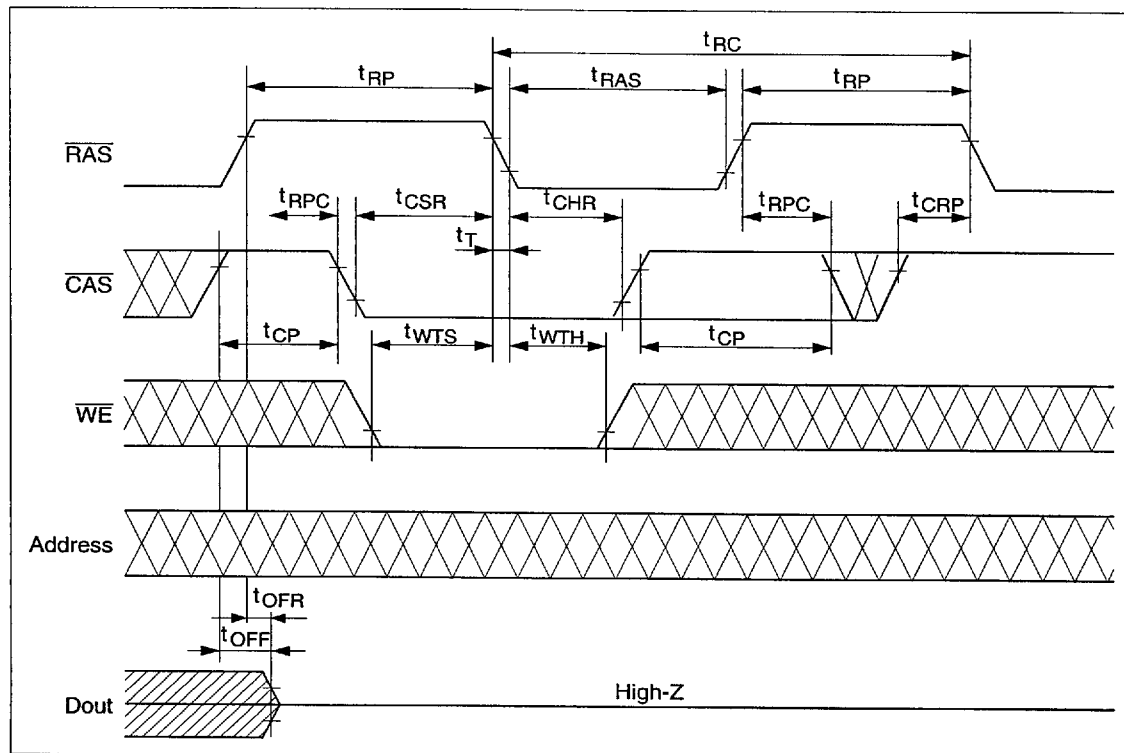


Test Mode Cycle *19



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Test Mode Set Cycle



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Package Dimensions

HM5116405SI/LSI Series (CP-26/24DB)

Unit: mm

